

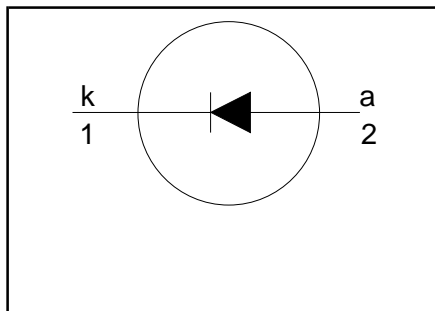
Damper diode fast, high-voltage

BY329X-1500, BY329X-1500S

FEATURES

- Low forward volt drop
- Fast switching
- Soft recovery characteristic
- High thermal cycling performance
- Isolated mounting tab

SYMBOL



QUICK REFERENCE DATA

$V_R = 1500\text{ V}$
$V_F \leq 1.35\text{ V} / 1.5\text{ V}$
$I_{F(\text{peak})} = 6\text{ A}$ ($f = 16\text{ kHz}$)
$I_{F(\text{peak})} = 6\text{ A}$ ($f = 70\text{ kHz}$)
$I_{FSM} \leq 75\text{ A}$
$t_{rr} \leq 230\text{ ns} / 160\text{ ns}$

GENERAL DESCRIPTION

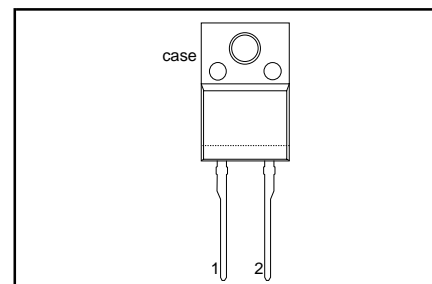
Glass-passivated double diffused rectifier diode featuring low forward voltage drop, fast reverse recovery and soft recovery characteristic. The device is intended for use in TV receivers and PC monitors.

The BY329X series is supplied in the conventional leaded SOD113 package.

PINNING

PIN	DESCRIPTION
1	anode
2	cathode
tab	isolated

SOD113



LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.		UNIT
V _{RSM}	Peak non-repetitive reverse voltage	BY329X f = 16 kHz f = 70 kHz t = 25 μs; δ = 0.5; T _{hs} ≤ 86 °C t = 10 ms sinusoidal; T _j = 150 °C prior to surge; with reapplied V _{RWM(max)}	-	1500		V
V _{RRM}	Peak repetitive reverse voltage		-	1500		V
V _{RWM}	Crest working reverse voltage		-	1300		V
I _{F(peak)}	Peak working forward current		-	-1500 6	-1500S -	A
			-	-	6	A
I _{FRM}	Peak repetitive forward current		-	14		A
I _{F(RMS)}	RMS forward current		-	11		A
I _{FSM}	Peak non-repetitive forward current		-	75		A
T _{stg}	Storage temperature	-40	150		°C	
T _j	Operating junction temperature	-	150		°C	

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ISOLATION LIMITING VALUE & CHARACTERISTIC

 $T_{hs} = 25\text{ }^{\circ}\text{C}$ unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V_{isol}	R.M.S. isolation voltage from both terminals to external heatsink	$f = 50\text{-}60\text{ Hz}$; sinusoidal waveform; $R.H. \leq 65\%$; clean and dustfree	-		2500	V
C_{isol}	Capacitance from both terminals to external heatsink	$f = 1\text{ MHz}$	-	10	-	pF

THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$R_{th\ j-hs}$	Thermal resistance junction to heatsink	with heatsink compound	-	-	4.8	K/W
$R_{th\ j-a}$	Thermal resistance junction to ambient	without heatsink compound in free air.	-	-	5.9	K/W
			-	55	-	K/W

STATIC CHARACTERISTICS

 $T_j = 25\text{ }^{\circ}\text{C}$ unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	TYP.		MAX.		UNIT
		BY329X-	1500	1500S	1500	1500S	
V_F	Forward voltage	$I_F = 6.5\text{ A}$	1.1	1.3	1.45	1.6	V
		$I_F = 6.5\text{ A}; T_j = 125\text{ }^{\circ}\text{C}$	1.05	1.2	1.35	1.5	V
I_R	Reverse current	$V_R = 1300\text{ V}$	-	250	-	250	μA
		$V_R = 1300\text{ V}; T_j = 125\text{ }^{\circ}\text{C}$	-	1	-	1	mA

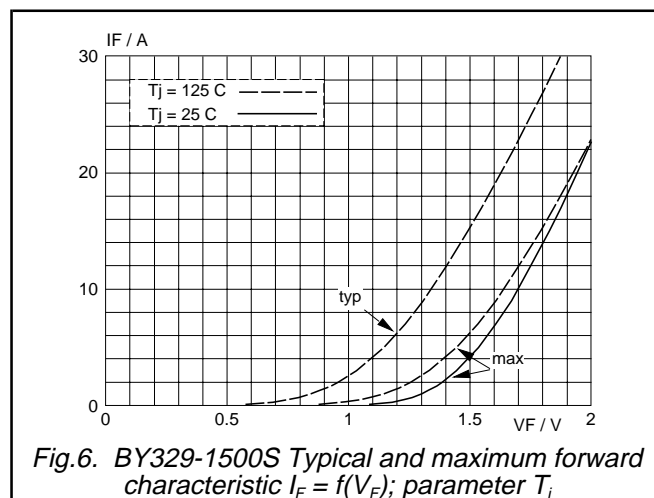
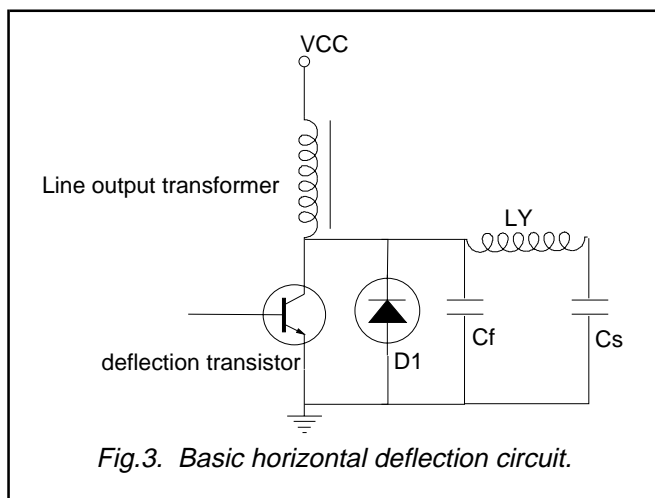
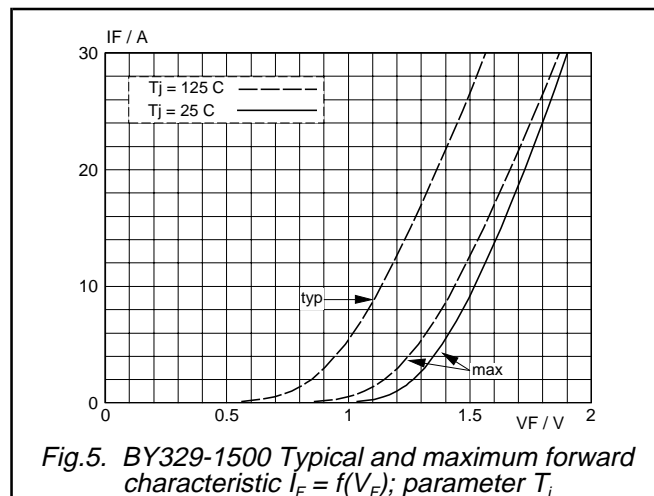
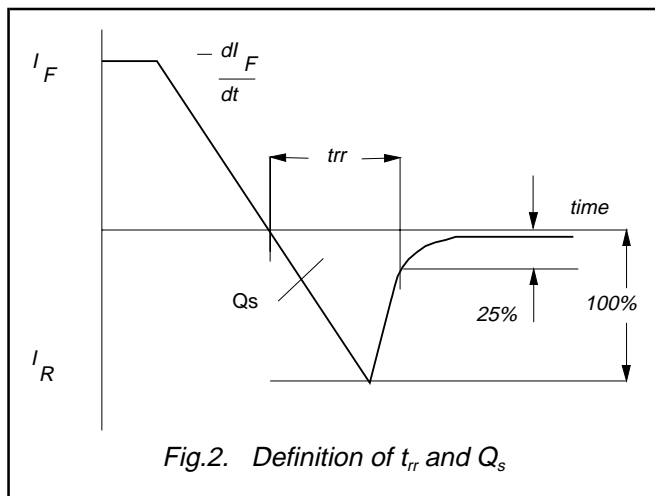
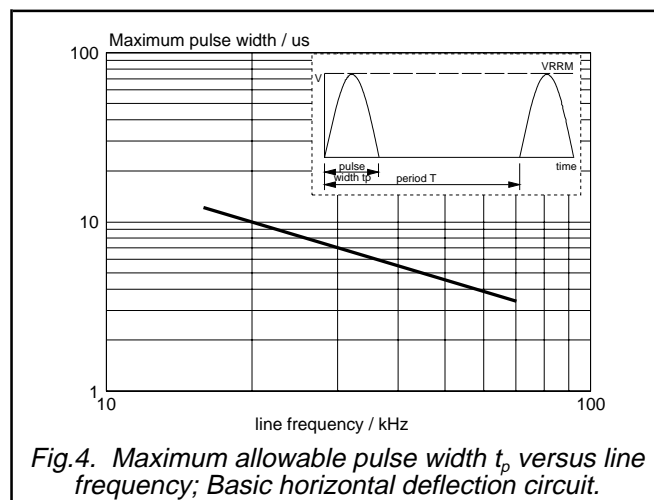
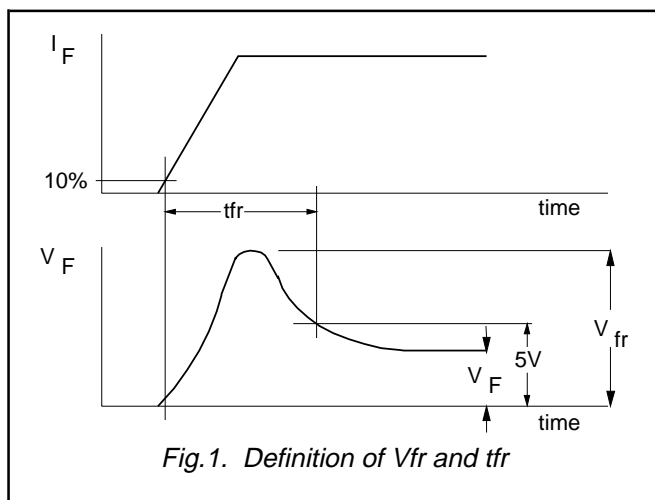
DYNAMIC CHARACTERISTICS

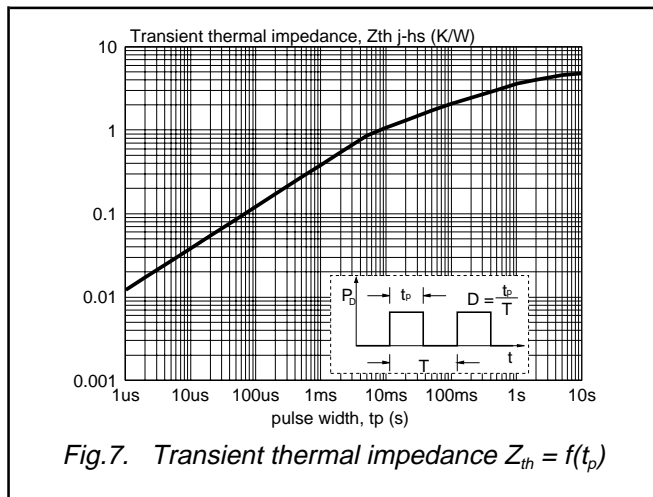
 $T_j = 25\text{ }^{\circ}\text{C}$ unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	TYP.		MAX.		UNIT
		BY329X	1500	1500S	1500	1500S	
t_{rr}	Reverse recovery time	$I_F = 1\text{ A}; V_R \geq 30\text{ V};$ $di_F/dt = 50\text{ A}/\mu\text{s}$	0.18	0.13	0.23	0.16	μs
Q_s	Reverse recovery charge	$I_F = 2\text{ A}; -di_F/dt = 20\text{ A}/\mu\text{s}$	1.6	0.7	2.0	0.95	μC
V_{fr}	Peak forward recovery voltage	$I_F = 6.5\text{ A}; di_F/dt = 50\text{ A}/\mu\text{s}$	17	23	30	40	V
t_{fr}	Forward recovery time	$I_F = 6.5\text{ A}; di_F/dt = 50\text{ A}/\mu\text{s}$	210	220	300	320	ns

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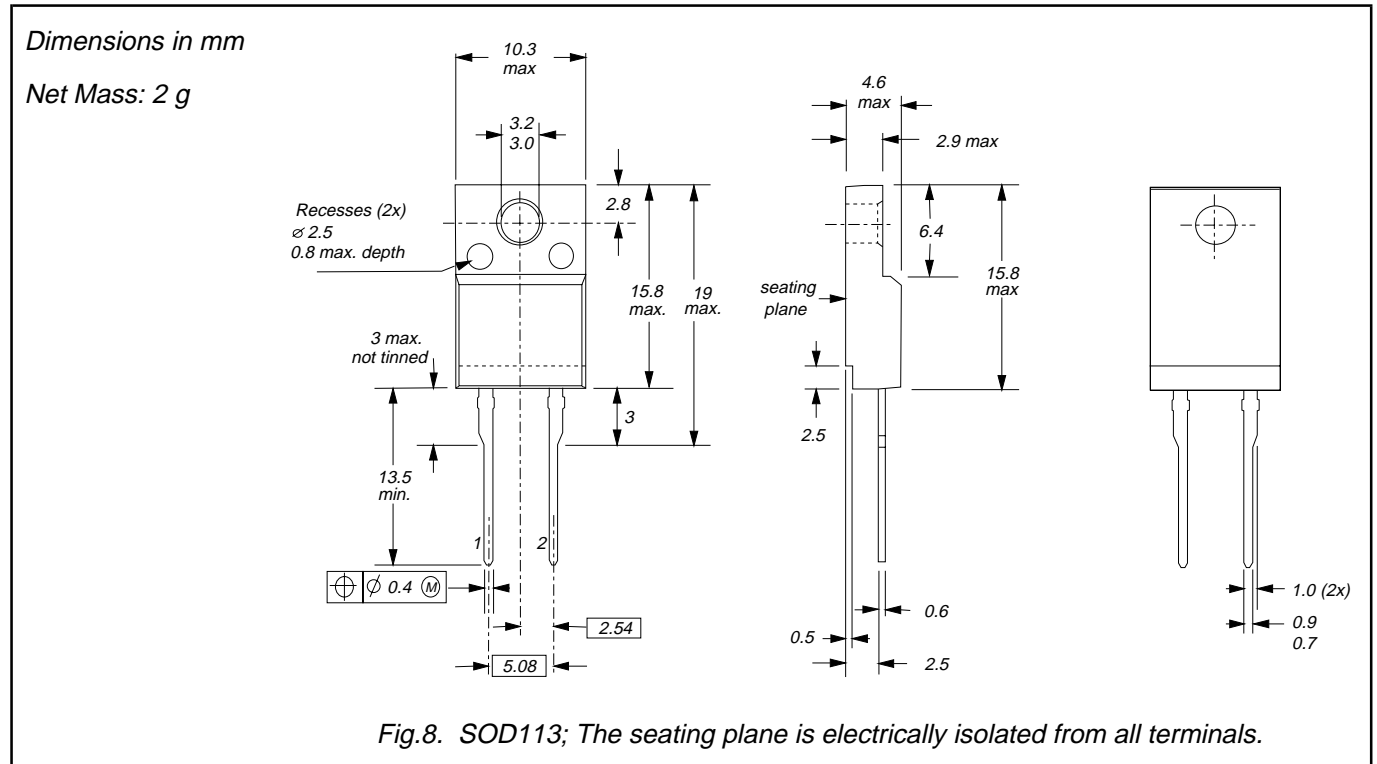


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MECHANICAL DATA



Notes

1. Refer to mounting instructions for F-pack envelopes.
2. Epoxy meets UL94 V0 at 1/8".

**Damper diode
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Data sheet status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	
Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
Application information	
Where application information is given, it is advisory and does not form part of the specification.	
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